

Determining the Electronic Structure and Thermoelectric Properties of MoS₂/MoSe₂ Type-I Heterojunction by DFT and the Landauer Approach

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The electronic structure and thermoelectric properties of MoX₂ (X = S, Se) Van der Waals heterojunctions are reported, with the intention of motivating the design of electronic devices using such materials. Calculations indicate the proposed heterojunctions are thermodynamically stable and present a band gap reduction from 1.8 eV to 0.8 eV. The latter effect is highly related to interactions between metallic d-character orbitals and chalcogen p-character orbitals. The theoretical approach allows to predict a transition from semi-conducting to semi-metallic behavior. The band alignment indicates a type-I heterojunction and band offsets of 0.2 eV. Transport properties show clear n-type nature and a high Seebeck coefficient at 300 K, along with conductivity values (σ/τ) in the order of 10²⁰. Lastly, using the Landauer approach and ballistic transport, the proposed heterojunctions can be modeled as a channel material for a typical one-gate transistor configuration predicting subthreshold values of ≈ 60 mV dec⁻¹ and field-effect mobilities of ≈ 160 cm⁻² V⁻¹ s⁻¹.

an on-off ratio of about 10⁸,^[5] electron mobilities between 30 cm⁻² V⁻¹ s⁻¹ and 200 cm⁻² V⁻¹ s⁻¹,^[6] and a layered nature that allows new functionality by merging atomically thin parts of distinct materials. In addition, Van der Waals heterojunctions made of TMD are the subject of intense research^[7–11] as an attractive way to tune the electronic performance of devices. From this, exceptional properties can be found, including carrier tunneling,^[12] metallic states in Moiré patterns,^[13,14] and Van der Waals–Janus type heterojunctions.^[15]

In this regard, Roy et al. experimentally achieved Van der Waals heterojunctions between MoS₂/WSe₂ by mechanical exfoliation of the layers.^[16] They created a dual-gate device architecture that works based on the quantum tunneling of carriers, sim-

ilar to other reported Van der Waals heterojunctions like MoS₂/WS₂,^[17] PbI₂/MoS₂,^[18] and hexagonal boron nitride (h-BN)/MoS₂.^[19] Ji et al. studied a multilayer MoS₂/MoSe₂ heterostructure whereby Density Functional Theory (DFT) under different conditions of lattice constraint.^[20] The results predicted an enhancement in electron mobility about 1.5 times higher than in pure MoS₂ due to band structure change after heterojunction formation. In the former research, authors also considered

1. Introduction

Molybdenum disulfide (MoS₂) and layered transition metal dichalcogenides (TMD) are promising candidates for developing next-generation electronic, spintronic, and optoelectronic devices. This is because of several advantages as semiconductors, like a transition from indirect to direct band gap (in MoS₂ occurs ≈ 1.1 eV to ≈ 1.9 eV),^[1–3] excellent mechanical properties,^[4]

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different coupling conditions, which ultimately show a potential route for band gap engineering. Similarly, Zheng et al. proved by DFT calculations that charge transfer between layers depends on temperature and valence band maximum location on MoS₂/WS₂ heterojunctions.^[21] Recently, Bellus et al. investigated the band alignment in MoS₂/ReS₂ heterojunctions using DFT calculations.^[22] Their analysis reveals a type-I band alignment. Furthermore, the orbital projection indicates that both the valence band maximum (VBM) and the conduction band minimum (CBM) locate at the ReS₂ layer. This results in an incoherent charge transfer due to the lattice mismatch in the MoS₂/ReS₂ heterostructure. Terrones et al. showed that interlayer alignment and stacking order influenced the properties of Van der Waals heterojunctions, predicting indirect to direct band gap transition even at multilayer arrangements.^[23] Similar reports indicate that lattice constraint, interlayer alignment, and lattice mismatch play a critical role in determining both structural and electronic properties of such materials.^[24–26] For this, we argue that it is essential further investigation of the different coupling conditions and arrangements between MoS₂ and MoSe₂, thus, being able to predict their electronic structure, resembling the conditions taking place experimentally.

This work aims to determine the change in the electronic structure with coupling conditions of Van der Waals heterojunction between MoS₂ and MoSe₂ under a dispersion corrected DFT (DFT-D2) scheme. With this, we can determine if the proposed arrangement is feasible to implement as a channel material in, e.g., a field-effect transistor or solar cells. We predicted their thermodynamic stability and the resulting band alignment, either a type-I, -II, or -III heterojunction according to the literature. We examined two alignment conditions and two lattice matches between MoS₂ and MoSe₂. We found that after contact, the band gap of the interface reduced to ≈0.8 eV, which is comparably lower than MoS₂ and MoSe₂ intrinsic band gap. Thermoelectric calculations indicate that the heterojunction has an n-type nature, suitable for applications in electronics and photo-electronics. The numerical modeling by the Landauer approach reveals that the proposed heterojunction

can achieve excellent behavior as channel material, providing valuable information to pave the research in new TMD Van der Waals devices and applications.

2. Results and Discussion

2.1. Geometrical Optimization of the Heterojunctions

As a comparison point, the resulting interlayer distance for MoS₂ (d_i) is 0.303 nm and for MoSe₂ is 0.313 nm, both in agreement with the reported values of 0.309 nm and 0.32 nm,^[4,20] indicating an excellent description of the material by our choice of parameters; the complete parameters are listed in **Table 1**. MoS₂ and MoSe₂ optimized surfaces were used to generate two types of heterojunctions considering lattice match and alignment between MoS₂ and MoSe₂. We considered the alignment to occur in a zigzag or a chalcogen–chalcogen order, labeled as AB or AA, respectively (**Figure 1**). The lattice match between MoS₂ and MoSe₂ is as follows: first, we have MoS₂ used as a substrate to support MoSe₂, the latter constrained to the MoS₂ lattice parameters. With this, we had a multilayer MoSe₂ over MoS₂ with the two AB and AA alignments, having (MoS₂/MoSe₂)_{AB} and (MoS₂/MoSe₂)_{AA}, respectively. For a multi/single-layer situation, we set a single layer of MoSe₂ over multilayer MoS₂, also in AB and AA, having (MoS₂/MoSe₂)_{mAB} and (MoS₂/MoSe₂)_{mAA}, respectively. Second, we placed multilayer MoS₂ on top of a multilayer MoSe₂, where the former is constrained to the MoSe₂ lattice parameters. Including the multi/single-layer configurations, labels are (MoSe₂/MoS₂)_{AB}, (MoSe₂/MoS₂)_{AA}, (MoSe₂/MoS₂)_{mAB}, and (MoSe₂/MoS₂)_{mAA}, respectively, having in total eight possibilities of MoS₂/MoSe₂ assembly.

Due to lattice mismatch occurring between MoS₂ and MoSe₂, a tensile or compressive strain is naturally present at the heterojunction and is possible to quantify as a strain index $\varepsilon_1 = x \left(\frac{a_2}{a_1} - 1 \right)$, being a_2 the lattice parameter of the material on top and a_1 the lattice parameter of the material at the bottom; x

Table 1. Obtained lattice parameters (a and c), Van der Waals bond distance (d_{vdw}), binding energy (E_b), band gap (E_g), work function (W), dielectric constant ($\varepsilon/\varepsilon_0$), and conduction band alignment (ΔE_c) for all the heterojunction configurations, bulk-like, and single layer (SL) models.

Model	a [nm]	c [nm]	d_{vdw} [nm]	E_b [eV atom ⁻¹]	E_g [eV]	W [eV]	$\varepsilon/\varepsilon_0$ [-]	ΔE_c [eV]
(MoS ₂ /MoSe ₂) _{AB}	0.319	8.500	0.307	6.48×10^{-3}	0.70	4.423	13.6	-0.217
(MoS ₂ /MoSe ₂) _{AA}	0.319	8.500	0.322	1.18×10^{-2}	0.67	4.263	13.6	-0.217
(MoSe ₂ /MoS ₂) _{AB}	0.332	8.700	0.315	3.05×10^{-2}	0.02	4.287	14.0	0.217
(MoSe ₂ /MoS ₂) _{AA}	0.332	8.700	0.321	3.49×10^{-2}	0	5.032	14.90	0.217
(MoS ₂ /MoSe ₂) _{mAB}	0.319	5.500	0.298	-1.05×10^{-2}	0.81	4.737	11.8	-0.217
(MoS ₂ /MoSe ₂) _{mAA}	0.319	5.500	0.312	-9.15×10^{-4}	0.76	4.681	11.8	-0.217
(MoSe ₂ /MoS ₂) _{mAB}	0.332	5.700	0.279	3.15×10^{-3}	0.085	4.831	12.8	0.217
(MoSe ₂ /MoS ₂) _{mAA}	0.332	5.700	0.318	1.03×10^{-2}	0	4.621	14.0	0.217
MoS ₂ (bulk-like)	0.319	5.400	0.303 ^{a)}	–	1.66	–	10.2	–
MoSe ₂ (bulk-like)	0.332	5.550	0.313 ^{a)}	–	1.44	–	11.5	–
MoS ₂ (SL)	3.19	–	–	–	2.16	5.503	6.70	–
MoSe ₂ (SL)	3.32	–	–	–	1.98	4.772	6.55	–

^{a)}In this case d_{vdw} is the resulted interlayer distance (d_i) for bulk-like MoS₂ and MoSe₂.

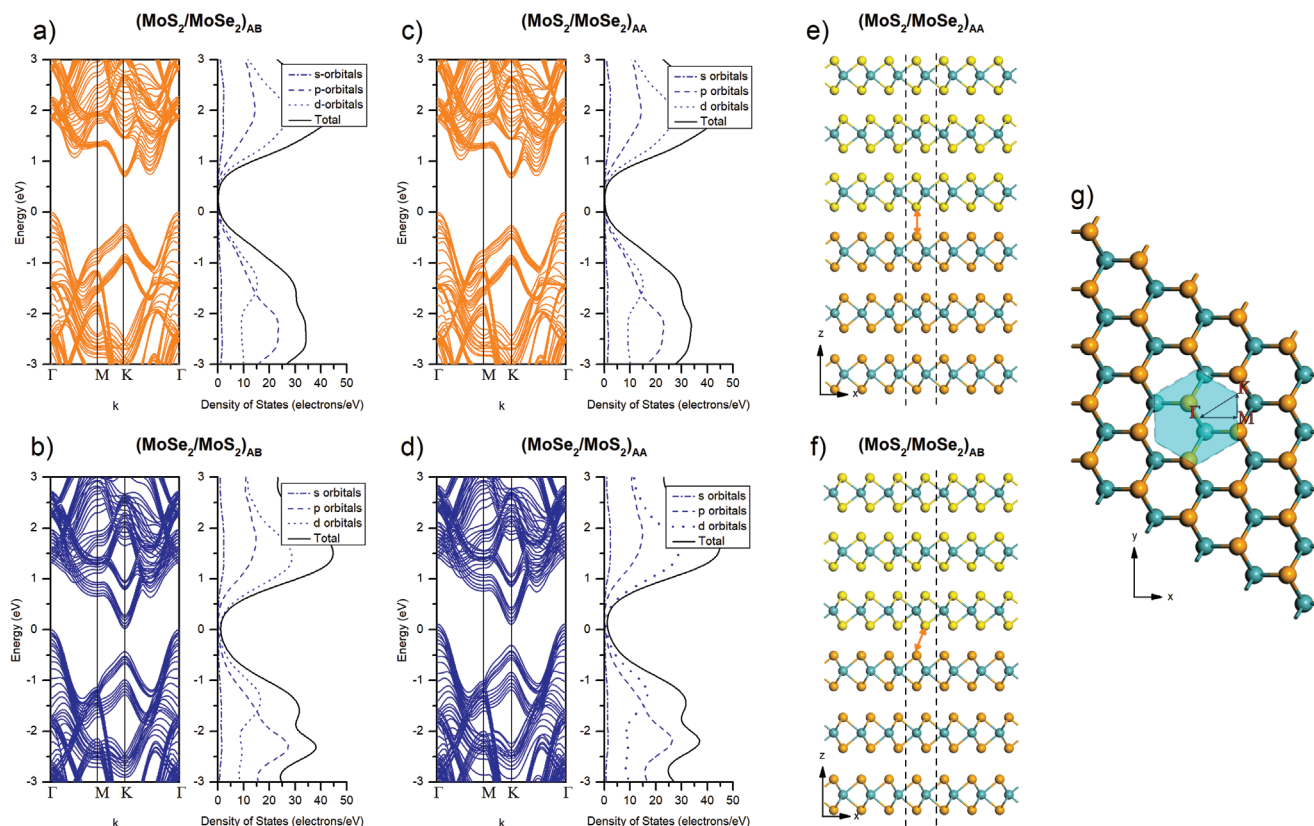


Figure 1. a–d) Resulted band structures and density of states for the multilayer heterojunctions in the AB and AA configuration, e) $(\text{MoS}_2/\text{MoSe}_2)_{\text{AB}}$, and f) $(\text{MoS}_2/\text{MoSe}_2)_{\text{AA}}$ heterojunction models where cyan balls represent molybdenum ions, yellow balls represent sulfur ions and orange selenium ones; the cell is extended in the z - x plane. Dashed lines in (e) and (f) represent the boundaries of the cell; orange arrows indicate the alignment between chalcogen ions. g) The Brillouin Zone and the Γ -M-K- Γ path used for the band structure calculation and the model extended in the y - x plane.

is the ratio of layers between material at the bottom and the total number of layers composing the heterojunction. Hence, a compression strain value of -1.96% is present at the $\text{MoSe}_2/\text{MoS}_2$ heterojunctions, while a tensile strain value of 2.04% is present at $\text{MoS}_2/\text{MoSe}_2$ configurations. In the multi/single-layer circumstance, a compression strain value of -0.33% and a strain value of 0.34% are present for $\text{MoSe}_2/\text{MoS}_2$ and $\text{MoS}_2/\text{MoSe}_2$ models, respectively. In terms of bonding distance between materials, AA alignment leads to larger values of Van der Waals binding distance (d_{vdW}) compared to AB alignments (Table 1); except for the case of $(\text{MoS}_2/\text{MoSe}_2)_{\text{mAA}}$ and $(\text{MoSe}_2/\text{MoS}_2)_{\text{mAB}}$ with the zigzag arrangement, all binding distance values resulted above 0.3 nm (Figure S1, Supporting Information).

The binding energy (E_b) helped to determine the thermodynamic stability of the heterojunction model, and it was computed using the following expression, in units of eV atom^{-1} ,

$$E_b = \frac{1}{n}(E_{\text{ht}} - E_{\text{MoS}} - E_{\text{MoSe}}) \quad (1)$$

being E_{ht} , E_{MoS} , E_{MoSe} , and n the total energy of the heterostructure, the total energy of MoS_2 surface, the total energy of MoSe_2 surface, and the number of atoms in the structure, respectively. Six of our eight models resulted in endothermic values of E_b , between $6.48 \times 10^{-3} \text{ eV atom}^{-1}$ and $1.03 \times 10^{-2} \text{ eV atom}^{-1}$ (see

also Table 1) with linear trend between multilayer and multi/single-layer arrangements (Figure S2, Supporting Information); these values compare to previous reports on similar heterojunction theoretical models.^[27] Endothermic values of binding energy do not necessarily indicate unfavorable or unstable structures. The order of magnitude of this result implies the presence of weak Van der Waals contacts, possibly by electrostatic interactions. This also suggests that energy demand is required to achieve the desired structure interpreted as a degree of control for experimental fabrication of Van der Waals heterostructures; it is possible to supply such an amount of energy by annealing process or photo-induced annealing as reported elsewhere.^[28,29]

2.2. Electronic Structure of $\text{MoS}_2/\text{MoSe}_2$ Heterojunctions

All $\text{MoS}_2/\text{MoSe}_2$ models, i.e., MoSe_2 is constrained to MoS_2 lattice, resulted in higher band gap values than $\text{MoSe}_2/\text{MoS}_2$ models; similarly, models with AB alignment resulted also with higher band gap values than models with AA alignment (Table 1). $\text{MoSe}_2/\text{MoS}_2$ heterojunctions resulted in close-to-zero band gap values. This fact cannot be attributed to the exchange-correlation functional because our computations for bulk-like and single layer MoS_2 and MoSe_2 are in complete agreement

with similar reports in the literature.^[24,25,30] We attribute the reduction of the band gap to d-orbital contributions which are displaced to energy levels just inside the band gap (Figure 1) because of lattice constraint. According to our results, the highest band gap value was achieved by $(\text{MoS}_2/\text{MoSe}_2)_{\text{mAB}}$ heterojunction configuration, being $E_g = 0.805$ eV (indirect band gap at Γ -K). On the other hand, $(\text{MoSe}_2/\text{MoS}_2)_{\text{AA}}$ and $(\text{MoSe}_2/\text{MoS}_2)_{\text{mAA}}$ models do not present any band gap, while $(\text{MoSe}_2/\text{MoS}_2)_{\text{AB}}$ and $(\text{MoSe}_2/\text{MoS}_2)_{\text{mAB}}$ cases yield a reduced band gap of 0.022 eV and 0.085 eV, respectively (Figure S3, Supporting Information).

We observe that in most $\text{MoSe}_2/\text{MoS}_2$ heterojunction configurations, the CBM becomes noticeable at the K point after the interface formation. This phenomenon causes an intercrossing with the Fermi level and, hence, a semi-metallic character, as reported in bent heterostructures.^[11,31,32] In contrast, $\text{MoS}_2/\text{MoSe}_2$ configuration has lesser metallic d-orbital contribution around the conduction band, translated as a lower disturbance of molybdenum d orbitals by interlayer interactions as previ-

ously suggested.^[11,33] Also, chalcogen orbitals' distribution, specifically 3p orbitals from sulfur and 4p from selenium, primarily contributing to the valence band, increase more pronounced at the $\text{MoSe}_2/\text{MoS}_2$ heterojunction, getting dispersed to higher energy values and causing band gap reduction, supporting our premise on lattice constraint and band gap reduction.

2.2.1. Band Offset and Band Alignment Calculation

In this work, we considered the position of the macroscopic average electrostatic potential of both materials, MoS_2 and MoSe_2 , throughout the interface and used it as a reference point to locate the bulk VBM. With this, we estimated the band alignment in the $\text{MoS}_2/\text{MoSe}_2$ heterojunction as done in other reports.^[34,35] This macroscopic potential generates a potential band offset determined by the difference in the electrostatic potential between the two regions (in the xy plane) of the heterojunction denoted as ΔV (Figure 2). Electrostatic

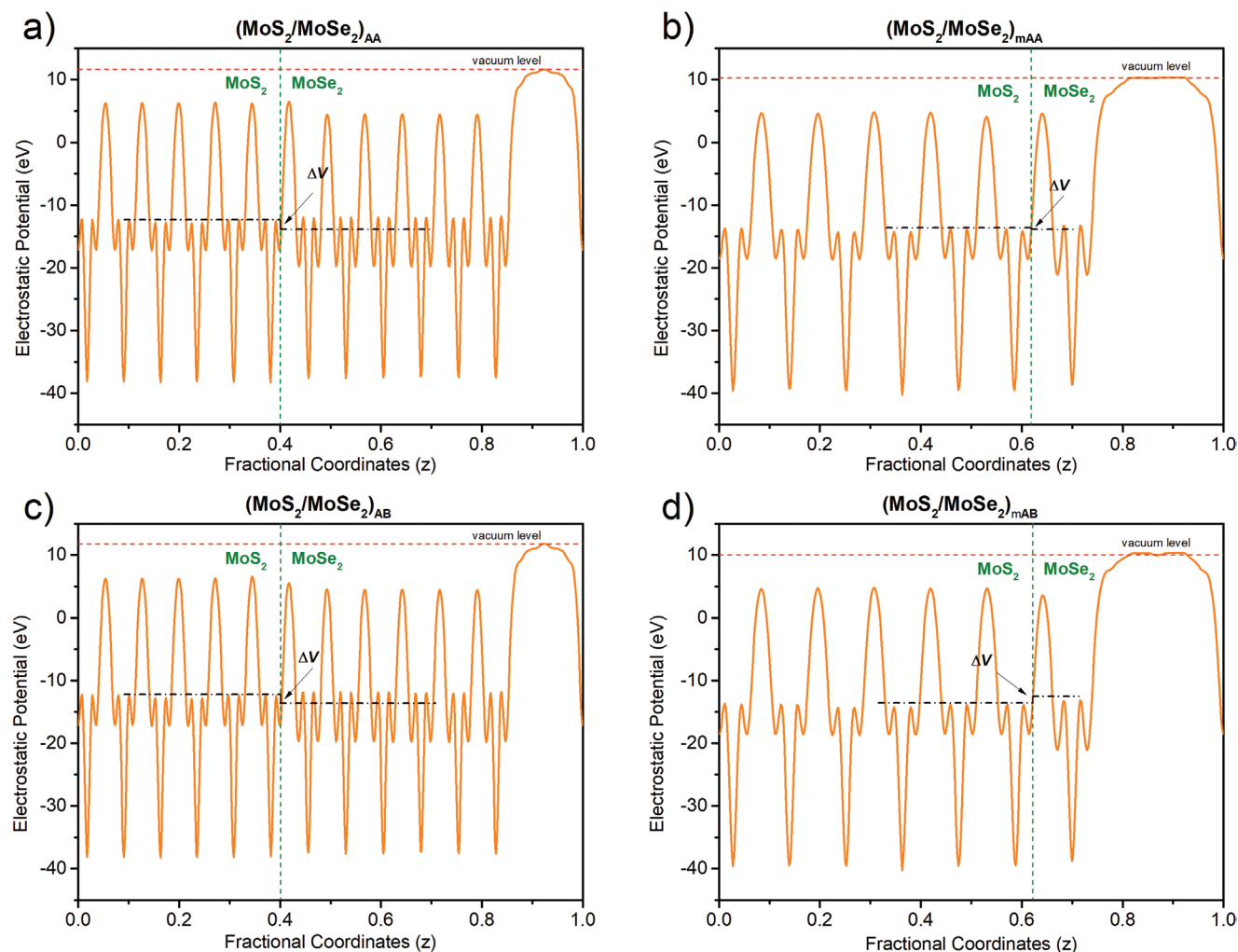


Figure 2. Averaged electrostatic potentials plots (in the xy plane) of $\text{MoS}_2/\text{MoSe}_2$ heterojunction configurations; green line indicates the point at which the interface is located, red line indicates the position of vacuum level. Dashed-dotted lines represent the average electrostatic potential of both materials and ΔV is the difference in the electrostatic potential energy.

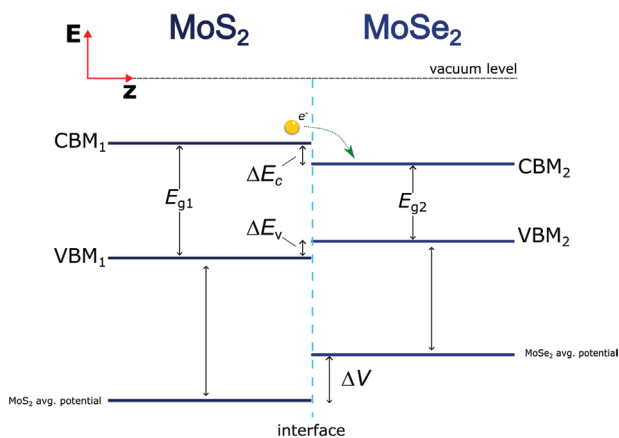


Figure 3. Schematic of band alignment between MoS₂/MoSe₂ heterojunction scenarios, where is possible to observe the ΔE_c and ΔE_v , which are the energy difference of conduction and valence bands, respectively.

potential plots for the MoSe₂/MoS₂ heterojunction configuration are depicted in Figure S4 (Supporting Information). Then, the valence band offset is computed as

$$\Delta E_v = E_v^{\text{top}} - E_v^{\text{bottom}} + \Delta V \quad (2)$$

where E_v^{top} and E_v^{bottom} are the location of the valence band maximum of the material atop and at the bottom in each of our proposed heterojunction models concerning the average electrostatic potential. Finally, the conduction band offset is found as

$$\Delta E_c = E_g^{\text{top}} - E_g^{\text{bottom}} + \Delta E_v \quad (3)$$

where E_g^{top} and E_g^{bottom} are the band gap values of the material placed on top and at the bottom in the heterostructure models. Computation gives $\Delta E_c = -0.217$ eV for MoS₂/MoSe₂ heterojunctions, while $\Delta E_c = 0.217$ eV resulted for MoSe₂/MoS₂ (Table 1) corresponding to a type-I heterostructure and represented in **Figure 3**. Our results on ΔE_c are comparable to those reported in polar and nonpolar heterostructures using ZnO, GaN, and MgGeN₂;^[24] Quan et al. estimated experimentally a ΔE_c of 0.46 eV in a MoTe₂/MoS₂ nanocomposite film,^[36] comparable to our estimation. Thus, this indicates the potential use of MoS₂/MoSe₂ heterojunction in electronic devices. In this case, charge carriers (electrons or holes) get confined at the material with the lower band gap due to this band alignment. The effect of charge confinement has been reported in Si/MoS₂ heterostructures,^[37] helping to increase charge injection yield. This result could be used as theoretical insights in designing metal-oxide field-effect transistors (MOSFET) and improved solar cells devices using TMD heterojunctions as channel materials.

In MoSe₂/MoS₂ heterojunction configurations, theoretically, an inverted version of the band alignment described in **Figure 3** should describe the behavior of the bands after contact, but as presented by band structure calculations, a semi-metallic nature indicates a much more complicated band alignment, possibly with induced gap states and dipole formation at the interface.

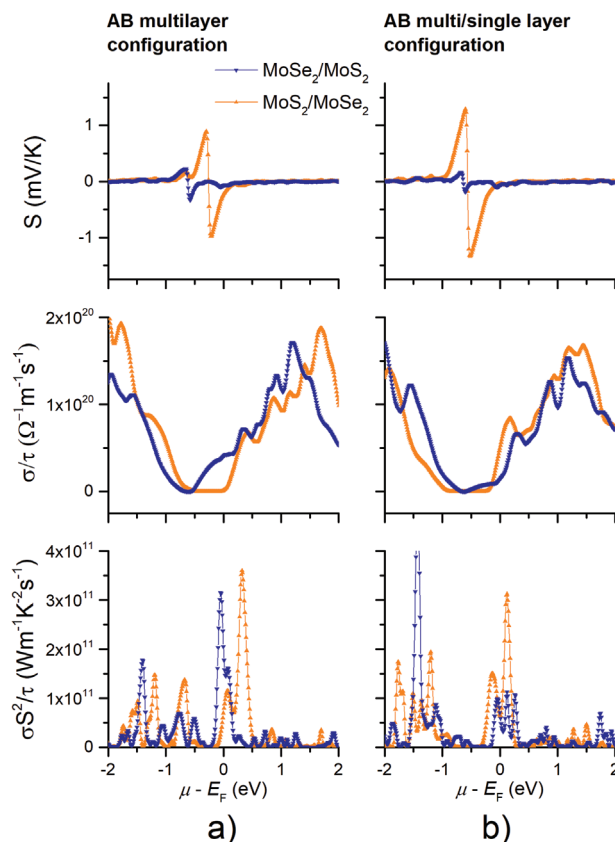


Figure 4. Seebeck coefficient (S), conductivity (σ/τ) and power factor ($S^2\sigma/\tau$) calculation for AB heterojunction configuration at 300 K as function of $\mu - E_0$. Seebeck coefficient values of MoS₂/MoSe₂ indicate a semiconductor behavior around the Fermi level. Power factor ($S^2\sigma/\tau$) values are higher at the MoS₂/MoSe₂ heterojunctions because of their higher values of Seebeck coefficient.

2.3. Thermoelectric Properties

For further analysis, the Seebeck coefficient (S) allows us to predict the behavior of charge carriers along energy levels near the Fermi level. From our calculations of the Seebeck coefficient, in all heterojunctions the crossover from hole-controlled to electron-controlled conduction, i.e., going from positive to negative values, takes place before $\mu - E_F = 0$ (**Figure 4**), indicating that electron-controlled conduction dominates.^[38] Seebeck coefficient is symmetric around the crossover point in MoS₂/MoSe₂ heterojunction configurations; however, the MoSe₂/MoS₂ configurations are slightly asymmetrical just around the crossover point.

We observe that the Seebeck coefficient in (MoS₂/MoSe₂)_{mAB} heterojunction resulted in ≈ 1300 $\mu\text{V K}^{-1}$, the highest value found (**Figure 4**). By contrast, (MoSe₂/MoS₂)_{mAB} has the lowest Seebeck coefficient of all heterojunction configurations studied, at about 210 $\mu\text{V K}^{-1}$. Our computed Seebeck coefficient values are consistent with previous experimental measurements on few-layer MoS₂ and MoS₂/WSe₂ heterojunction,^[39–41] only being somewhat overestimated, attributed to factors like electron-phonon scattering, recombination processes, and structural defects. In addition, the crossover in MoSe₂/MoS₂ heterojunctions takes place at lower energy levels than in MoS₂/MoSe₂,

which can be associated with the low band gap and semi-metallic behavior observed in the band structure plots.

Calculations on conductivity per relaxation time (σ/τ) show a pronounced n-type character for MoS₂/MoSe₂ heterojunctions (Figure 4). In contrast, MoSe₂/MoS₂ confirms our previous suggestions where MoSe₂/MoS₂ heterojunctions have a semi-metallic behavior due to metallic d-orbital reallocation. Thermoelectric properties for heterojunctions in the AA configuration have the same trend as the AB configuration, indicating little dependence on this alignment condition (Figure 4 and Figure S5, Supporting Information). In general, MoS₂/MoSe₂ heterojunctions in the multi/single configuration have improved transport properties than the other configurations considered in this work, with higher Seebeck coefficient and values of σ/τ around the band gap in the order of 10^{20} . This behavior follows previous work suggesting that multilayer configurations of MoS₂ have enhanced light adsorption.^[42] In terms of the power factor ($S^2\sigma/\tau$), MoS₂/MoSe₂ heterojunctions are superior to MoSe₂/MoS₂ ones due to higher values of the Seebeck coefficient.

2.4. Heterojunction Model in a One-Gate Configuration

As a further examination, we model our heterojunction as a one-gate device resembling a transistor configuration. For this, we consider the Landauer approach, the ballistic transport regime, and non-degenerate statistics. We computed the current versus drain-to-source voltage (I - V) characteristic using the following expression

$$I_{ds} = wQ_n v_t \left[\frac{1 - e^{-qV_{ds}/k_b T}}{1 + e^{-qV_{ds}/k_b T}} \right] \quad (4)$$

which is a function of the surface charge (Q_n) that varies with respect to the drain to source voltage (V_{ds}) and gate voltage (V_{gs}). v_t represents the charge thermal velocity in the ballistic regime (and non-degenerate statistics) and w is the width of the device. A more detailed description of this approach is provided in the Supporting Information. We aimed to test the material's capabilities for electronic applications, benefiting from the resulting type-I alignment. The only heterojunctions considered are (MoS₂/MoSe₂)_{AB} and (MoS₂/MoSe₂)_{mAB} based on our previous results on band structure and thermoelectric calculations.

First, the surface charge needed to be computed, denoted by Q_n , for each of the considered heterojunction models. This was by using a semi-empirical expression developed by Wright et al.,^[43] which states that

$$Q_n = -mC_g \left(\frac{k_b T}{q} \right) \ln \left(1 + e^{q(V_{gs} - V_t)/mk_b T} \right) \quad (5)$$

where m is the body effect parameter (≈ 1 for thin oxide layers), C_g is the gate capacitance, V_t is the threshold voltage, and k_b is the Boltzmann constant. To evaluate C_g we considered HfO₂ as dielectric material—high dielectric constant of 25—with a thickness (t_{ox}) of 10 nm (see Supporting Information). Similarly, we employed the resulting dielectric constant of 13.6 for the MoS₂/MoSe₂ multilayer heterojunction configuration and

a dielectric constant of 11.8 for the MoS₂/MoSe₂ multi/single-layer heterojunction (Table 1). We extracted these values at the limit where the dielectric function of the heterojunctions approaches zero ($\epsilon(E) \rightarrow 0$). The semiconductor thickness (t_s) was set to 7.2 nm which is approximately the thickness of our heterojunction models.

Second, we input the following parameters and function Q_n into Equation (4) to compute the I - V characteristics of the modeled one-gate device: a thermal velocity $v_t = \sqrt{\frac{2k_b T}{\pi m^*}}$ considering an electron effective mass (m^*) of MoS₂/MoSe₂ approximately equal to the effective mass of MoS₂,^[20,44] being $0.46m_0$; a width (w) of the one-gate device of 400 nm, and a channel length of 10 nm.^[45] Finally, the drain-to-source voltage was set to -100 mV, while the threshold voltage was -10 V, -5 V, and -1 V. We first validate our model by comparing theoretical I - V characteristics utilizing the parameters of devices as reported in the literature. We found an excellent agreement of our I - V approach with experimentally obtained I - V curves (see Figure S5, Supporting Information), and after that, we proceeded with our parameters as mentioned above.

From the resulting I - V relations of our modelled one-gate device (Figure 5), we estimated a subthreshold swing (SS) of 60 mV dec⁻¹, field-effect mobility (μ_f) of 160 cm² V⁻¹ s⁻¹, and an on/off ratio of the order of 10^5 using a threshold voltage of -1 V at -100 mV drain-to-source voltage and a MoS₂/MoSe₂ heterojunctions in multilayer configuration (Figure 5a). MoS₂/MoSe₂ heterojunctions in multilayer configuration output higher current compared to multi/single-layer ones (Figure 5b), which agrees with the calculations of σ/τ presented earlier. The order of magnitude of the output current agrees with experimental data available (see Supporting Information), confirming that our methodology can potentially assist in designing electronic and opto-electronics devices integrating TMD.

3. Conclusions

Our results from DFT allowed us to determine the electronic structure and transport properties of Van der Waals multilayer and multi/single-layer of MoS₂/MoSe₂ and MoSe₂/MoS₂ heterostructures with a zigzag (AB) and chalcogen-chalcogen (AA) interlayer alignment. After the formation of the interface, the resulting band gap is around 0.8 eV with a band offset of about 0.2 eV. The MoS₂/MoSe₂ heterojunction preserves their semiconducting characteristics. However, MoSe₂/MoS₂ configurations have semi-metallic behavior. This shift is strongly related to the interlayer coupling due to induced strain and subsequent reallocation of metallic d-orbital and chalcogen orbitals in energy levels inside the band gap. The resulting band alignment of MoS₂/MoSe₂ (in AA and AB alignment configurations) indicates a type-I heterojunction, especially useful in designing optoelectronic and electronic devices. Moreover, the heterojunction presents an excellent Seebeck coefficient of ≈ 1000 μ V K⁻¹ and conductivity values (σ/τ) around the band gap in the order of 10^{20} . Numerical modeling of our material in a one-gate transistor indicates excellent behavior as channel material with subthreshold swing values of 60 mV dec⁻¹ and

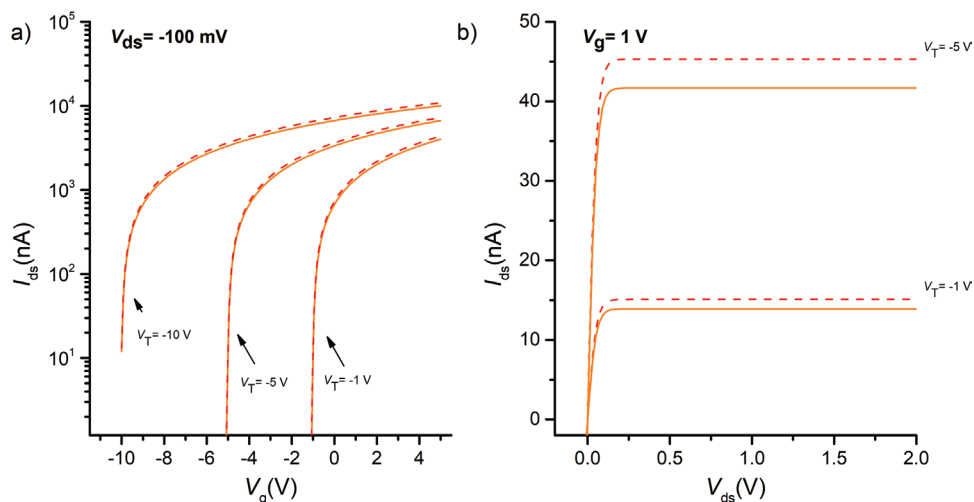


Figure 5. a) Drain-to-source current (I_{ds}) as function of applied gate voltage (V_g) at a constant drain-to-source voltage (V_{ds}) of -100 mV and setting three threshold voltages (V_T): -10 , -5 , and -1 V. Dashed lines correspond to the calculations using the MoS₂/MoSe₂ multilayer heterojunctions configuration with an estimated dielectric constant of 13.6; solid lines correspond to the MoS₂/MoSe₂ multi/single-layer heterojunctions with a dielectric constant of 11.8. b) I_{ds} as a function of V_{ds} with $V_g = 1$ V at different values of V_T .

field-effect mobilities of about $160 \text{ cm}^{-2} \text{ V}^{-1} \text{ s}^{-1}$. As presented here, these heterojunctions have promising applications in electronic and optoelectronics applications, owing to their remarkable electronic and thermoelectric properties.

4. Experimental Section

Density Functional Calculations: Geometric optimization calculations were completed using DFT code CASTEP^[46] employing the revised Perdew–Burke–Ernzerhof (RPBE) as the exchange–correlation functional, part of the Generalized Gradient Approximation (GGA). Geometric optimization criteria were set as follows: cutoff energy at 500 eV, a self-consistent field tolerance of 10^{-6} eV atom⁻¹, a k-point separation of 0.6 nm^{-1} (0.06 \AA^{-1}), a maximum displacement of 10^{-4} nm (10^{-3} \AA), a convergence tolerance for maximum energy difference of 10^{-5} eV atom⁻¹, and a maximum force threshold of 0.3 eV nm^{-1} ($3 \times 10^{-2} \text{ eV \AA}^{-1}$). The ultrasoft pseudopotentials and the semi-empirical DFT-D2 adjustment were employed in all the DFT calculations for long-range dispersion correction as described by Grimme^[47] and as used in previous studies for accurate description of layered materials.^[20,48–50] For the electronic structure estimation, GGA and Perdew–Burke–Ernzerhof (PBE) were chosen, along with a k-point separation of 0.01 nm^{-1} (0.001 \AA^{-1}) in the Γ -M-K- Γ path. Thermoelectric properties were calculated using Boltztrap2 code^[51] which solves the linearized Boltzmann transport equation. The quasi-particle energies were calculated with WIEN2k code^[52] and used as input for Boltztrap2 calculations; details are provided in the Supporting Information.

Molecular Models of MoS₂/MoSe₂ Heterojunction: The optimized MoS₂ and MoSe₂ unit cells (space group P63/mmc) had lattice parameters of $a = b = 0.319 \text{ nm}$ and $c = 1.27 \text{ nm}$ and $a = b = 0.332 \text{ nm}$ and $c = 1.29 \text{ nm}$, respectively. Using these models, the MoS₂ and MoSe₂ surfaces were constructed in the $\langle 002 \rangle$ direction, setting a thickness of $\approx 2.0 \text{ nm}$ for each. This surface model consists of six Mo atoms and twelve chalcogen atoms (either S or Se), and each of these surfaces resembles a bulk-like material. The heterojunction models were assembled as mentioned previously in the text. A vacuum space of $\approx 1.5 \text{ nm}$ in the z direction separates periodic images, avoiding undesired contacts and interactions. These surface and heterojunction models were subjected to geometry optimization using the abovementioned parameters.

Supporting Information

Supporting Information is available from the Wiley Online Library or from the author.

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Conflict of Interest

The authors declare no conflict of interest.

Data Availability Statement

The data that support the findings of this study are available from the corresponding author upon reasonable request.

Keywords

band gap, density functional theory, heterojunctions, semiconductors

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